



News Release

Status of Unisem Chengdu after the earthquake

Kuala Lumpur - 13 May 2008 As reported in the news a severe earthquake has struck in China, Sichuan province near Chengdu with a great loss of life. Our heart-felt sympathy goes out to those in the community who have lost loved ones in this tragedy.

There is no major damage to the physical infrastructure of Unisem's factory in Chengdu as the epicenter was approximately 100 kilometers away. All our employees, customers and vendors who were present at Unisem Chengdu at the time of earthquake were evacuated and safe.

As a safety precaution, our factory was shut down for the remainder of Tuesday and will remain shut down on Wednesday while we do our complete assessment of all materials, equipment and the factory building. We will endeavour to apprise all stakeholders of the situation in a timely manner as it unfolds.

About Unisem

Unisem is a global provider of semiconductor assembly and test services for many of the world's most successful electronics companies. Unisem offers an integrated suite of packaging and test services such as wafer bumping, wafer probing, wafer grinding, a wide range of leadframe and substrate IC packaging, wafer level CSP and RF, analog, digital and mixed-signal test services. Our turnkey services include design, assembly, test, failure analysis, and electrical and thermal characterization. With approximately 9,500 employees worldwide, Unisem has factory locations in Ipoh, Malaysia; Wales, United Kingdom; Chengdu, People's Republic of China; Batam, Indonesia and Sunnyvale, USA. The company is headquartered in Kuala Lumpur, Malaysia. For more information about the company, its products and services, please visit its website at www.unisemgroup.com.